

High Efficiency Regulator Controller

FEATURES

- Complete Control for a High Current, Low Dropout, Linear Regulator
- Fixed 5V or Adjustable Output Voltage
- Accurate 2.5A Current Limiting with Foldback
- Internal Current Sense Resistor
- Remote Sense for Improved Load Regulation
- External Shutdown
- Under-Voltage Lockout and Reverse Voltage Protection
- Thermal Shutdown Protection
- 8 Pin Mini-Dip Package (Surface Mount also Available)

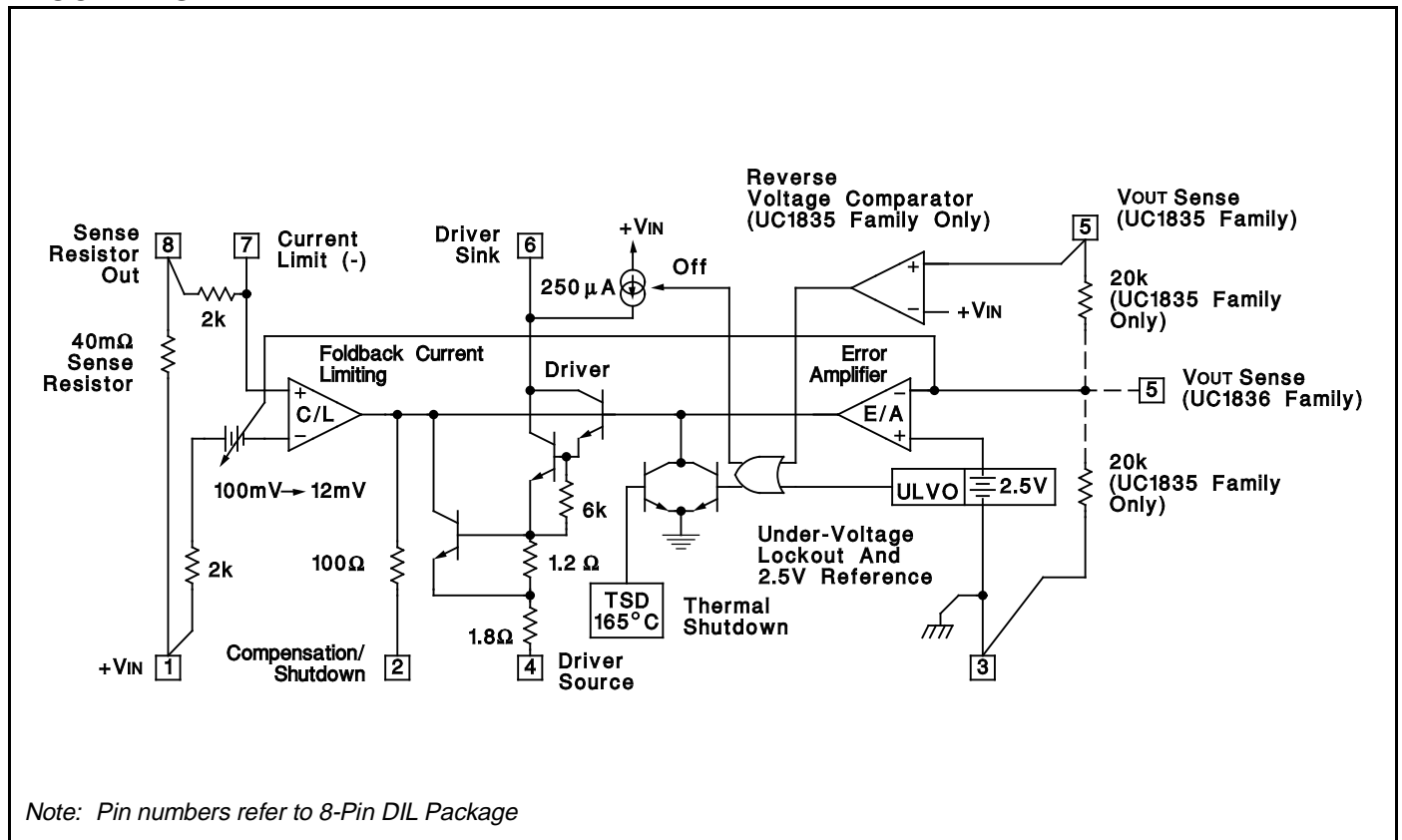
DESCRIPTION

The UC1835/6 families of linear controllers are optimized for the design of low cost, low dropout, linear regulators. Using an external pass element, dropout voltages of less than 0.5V are readily obtained. These devices contain a high gain error amplifier, a 250mA output driver, and a precision reference. In addition, current sense with foldback provides for a 2.5A peak output current dropping to less than 0.5A at short circuit.

These devices are available in fixed, 5V, (UC1835), or adjustable, (UC1836), versions. In the fixed 5 volt version, the only external parts required are an external pass element, an output capacitor, and a compensation capacitor. On the adjustable version the output voltage can be set anywhere from 2.5V to 35V with two external resistors.

Additional features of these devices include under-voltage lockout for predictable start-up, thermal shutdown and short circuit current limiting to protect the driver device. On the fixed voltage version, a reverse voltage comparator minimizes reverse load current in the event of a negative input to output differential.

BLOCK DIAGRAM



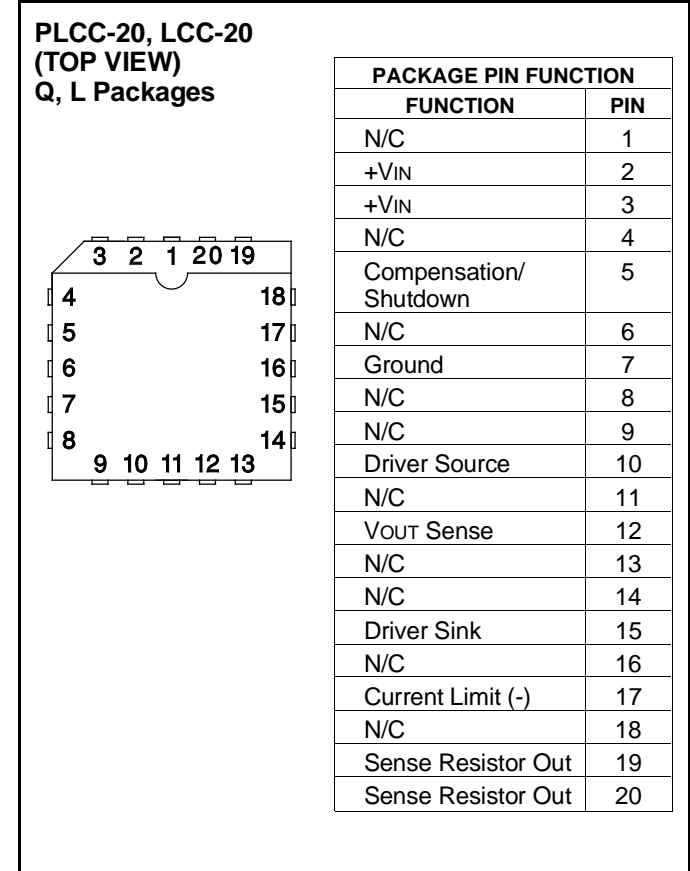
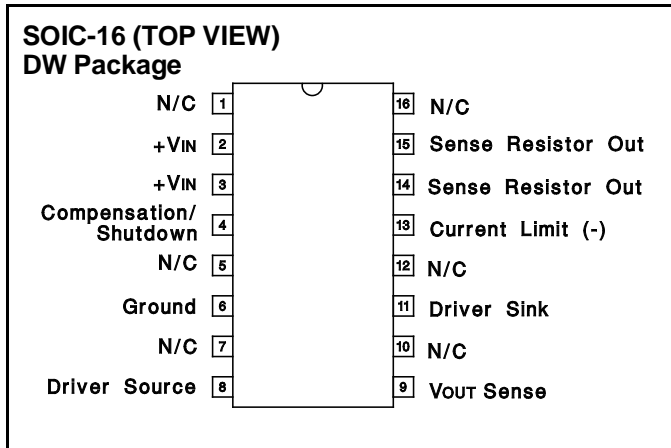
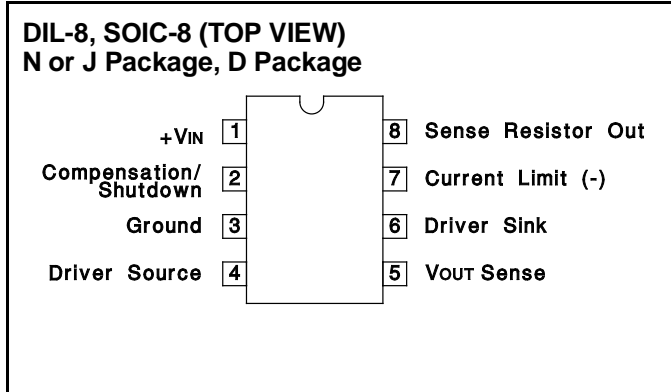
ABSOLUTE MAXIMUM RATINGS (Note 1)

Input Supply Voltage (+VIN)	-1.0V to +40V
Driver Output Current (Sink or Source)	600mA
Driver Source to Sink Voltage	+40V
Maximum Current Through Sense Resistor	4A
VOUT Sense Input Voltage	-.3V to +40V
Power Dissipation at TA = 25°C (Note 2)	1000mW
Power Dissipation at Tc = 25°C (Note 2)	2000mW

Operating Junction Temperature	-55°C to +150°C
Storage Temperature	-65°C to +150°C
Lead Temperature (Soldering, 10 Seconds)	300°C

Note 1: Voltages are referenced to ground, (Pin 3). Currents are positive into, negative out of, the specified terminals.
 Consult Packaging Section of Databook for thermal considerations and limitations of packages.

CONNECTION DIAGRAMS



ELECTRICAL CHARACTERISTICS: Unless otherwise stated, specifications hold for TA = 0°C to +70°C for the UC3835/6, -25°C to +85°C for the UC2835/6, and -55°C to +125°C for the UC1835/6, +VIN = 6V, Driver Source= 0V, Driver Sink = 5V, TA = TJ.

PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Supply					
Supply Current	+VIN = 6V		2.75	4.0	mA
	+VIN = 40V		3.75	6.0	mA
UVLO Threshold	+VIN Low to High, VOUT Sense = 0V	3.9	4.4	4.9	V
Threshold Hysteresis			0.1	0.35	V
Reverse Current	+VIN = -1.0V, Driver Sink Open		6.0	20	mA
Regulating Voltage and Error Amplifier (UC1835 Family Only)					
Regulating Level at VOUT Sense (VREG)	Driver Current = 10mA, TJ = 25°C	4.94	5.0	5.06	V
	Over Temperature	4.9		5.1	V
Line Regulation	+VIN = 5.2V + 35V		15	40	mV
Load Regulation	Driver Current = 0 to 250mA		6.0	25	mV
Bias Current at VOUT Sense	VOUT Sense = 5.0V	75	125	210	µA
Error Amp Transconductance	±100µA at Compensation/Shutdown Pin	0.8	1.3	2.0	mS
Maximum Compensation Output Current	Sink or Source, Driver Source Open	90	200	260	µA

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, specifications hold for $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$ for the UC3835/6, -25°C to $+85^\circ\text{C}$ for the UC2835/6, and -55°C to $+125^\circ\text{C}$ for the UC1835/6, $+V_{IN} = 6\text{V}$, Driver Source = 0V , Driver Sink = 5V , $T_A = T_J$.

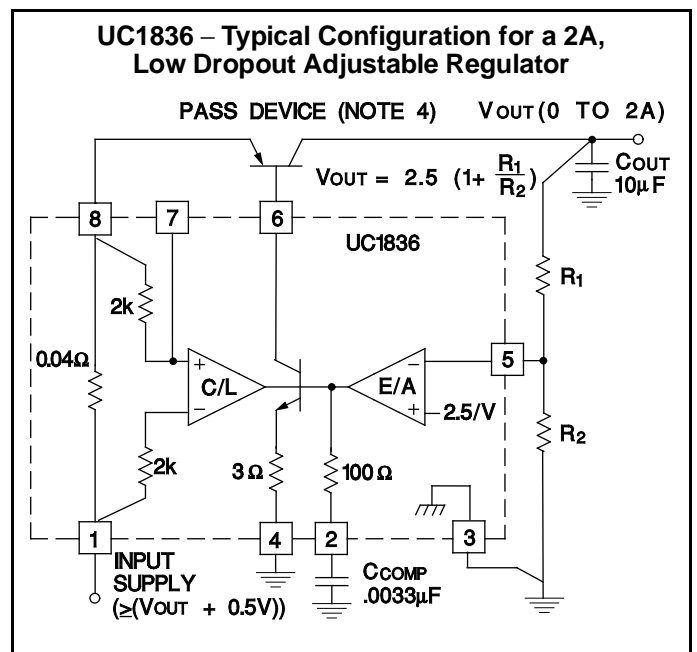
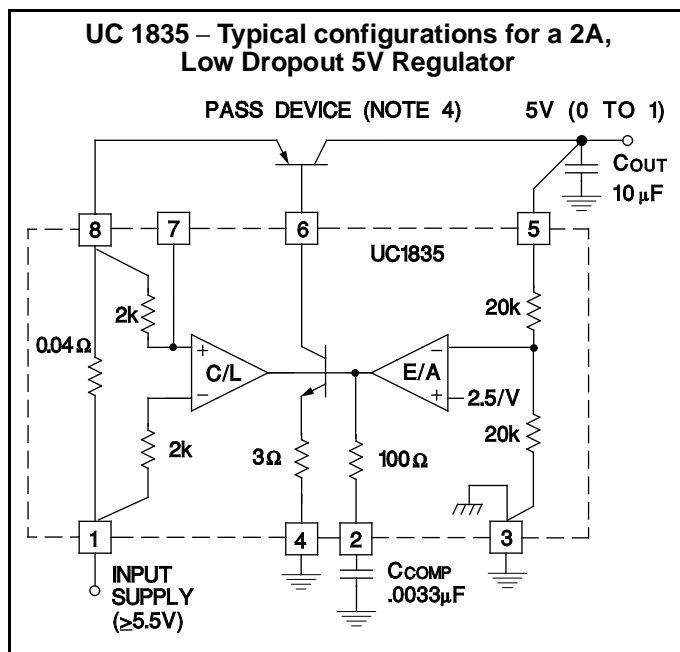
PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Regulating Voltage and Error Amplifier (UC1836 Family Only)					
Regulating Level at V_{OUT} Sense (V_{REG})	Driver Current = 10mA , $T_J = 25^\circ\text{C}$	2.47	2.5	2.53	V
	Over Temperature	2.45		2.55	V
Line Regulation	$+V_{IN} = 5.2\text{V}$ to 35V		6.0	20	mV
Load Regulation	Driver Current = 0 to 250mA		3.0	15	mV
Bias Current at V_{OUT} Sense	V_{OUT} Sense = 2.5V	-1.0	-0.2		μA
Error Amp Transconductance	$\pm 100\mu\text{A}$ at Compensation/Shutdown Pin	0.8	1.3	2.0	mS
Maximum Compensation Output Current	Sink or Source, Driver Source Open	90	200	260	μA
Driver					
Maximum Current		250	500		mA
Saturation Voltage	Driver Current = 250mA , Driver Sink		2.0	2.8	V
Pull-Up Current at Driver Sink	Compensation/Shutdown = 0.45V	140	250	300	μA
Driver Sink Leakage	In UVLO			10	μA
	In Reverse Voltage (UC1835 Family Only)			10	μA
Thermal Shutdown			165		$^\circ\text{C}$
Foldback Current Limit					
Current Limit Levels at Sense Resistor Out	V_{OUT} Sense = $(0.99) V_{REG}$	2.2	2.5	2.8	A
	V_{OUT} Sense = $(0.5) V_{REG}$	1.3	1.5	1.7	A
	V_{OUT} Sense = 0V	0.25	0.4	0.55	A
Current Limit Amp Transconductance	$\pm 100\mu\text{A}$ at Compensation/Shutdown, V_{OUT} Sense = $(0.9) V_{REG}$	12	24	42	mS
Limiting Voltage at Current Limit (-) (Note 2)	V_{OUT} Sense = $(0.9) V_{REG}$ Volts Below $+V_{IN}$, $T_J = 25^\circ\text{C}$	80	100	140	mV
Sense Resistor Value (Note 3)	V_{OUT} Sense = $(0.9) V_{REG}$, $I_{OUT} = I_A$, $T_J = 25^\circ\text{C}$		40		$\text{m}\Omega$

Note 2: This voltage has a positive temperature coefficient of approximately $3500\text{ppm}/^\circ\text{C}$.

Note 3: This resistance has a positive temperature coefficient of approximately $3500\text{ppm}/^\circ\text{C}$.

The total resistance from Pin 1 to Pin 8 will include an additional 60 to $100\text{m}\Omega$ of package resistance.

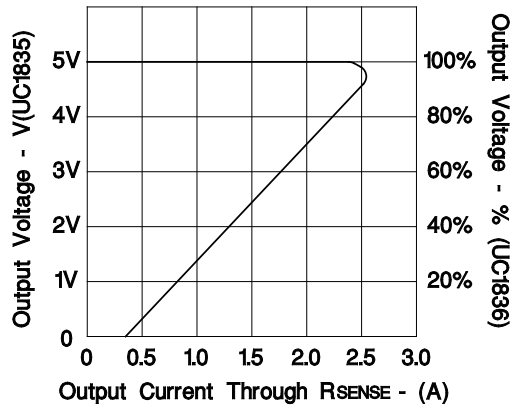
APPLICATION AND OPERATION INFORMATION



Note 4: Suggested Pass devices are TIP 32B. (Dropout Voltage $\leq 0.75\text{V}$) or, D45H, (Dropout Voltage $\leq 0.5\text{V}$), or equivalents.

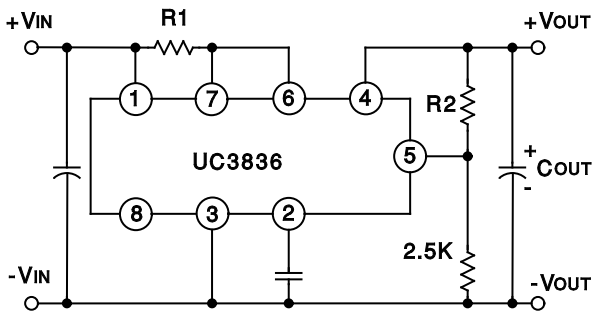
APPLICATION AND OPERATION INFORMATION (cont.)

UC1835/6 Foldback Current Limiting



UC3835/36 TYPICAL APPLICATIONS

Low Current Application
 using the UC3836 internal drive transistor

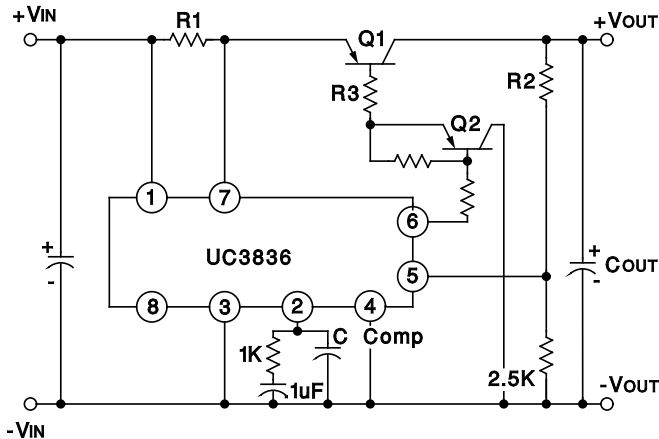


Typical Output Current vs VIN and VOUT
 of the UC3836 internal drive transistor
 for PDISS = 0.5W (approx.)

		VIN						
		Volts	5	9	12	15	18	24
VOUT	2	150	60	40	30	20	12	
	5		105	55	35	25	15	
	9			130	60	35	20	
	12				120	55	25	
	15					110	30	
		Current in mA						

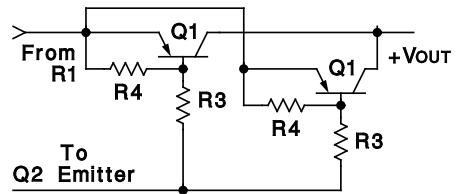
High Current Application

using drive transistor Q2 to increase Q1 base drive
 and reduce UC3836 power dissipation



Parallel Pass Transistors

can be added for high current or
 high power dissipation applications



EQUATIONS:

$$R1 = 0.100 V/I_{OUT} (MAX)$$

$$R2 = (V_{OUT} - 2.5V/1mA)$$

$$R3 = ((V_{IN} - V_{BE} - V_{SAT}) * BETA(min)) / I_{OUT} (max)$$

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-9065002PA	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9065002PA UC1836
UC1836J	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1836J
UC1836J.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1836J
UC1836J883B	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9065002PA UC1836
UC1836J883B.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9065002PA UC1836
UC2835D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2835D
UC2835D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2835D
UC2836D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2836D
UC2836D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-55 to 150	UC2836D
UC2836DG4	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2836D
UC3836D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3836D
UC3836D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3836D

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF UC1836, UC3836 :

- Catalog : [UC3836](#)
- Military : [UC1836](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
UC2835D	D	SOIC	8	75	506.6	8	3940	4.32
UC2835D.A	D	SOIC	8	75	506.6	8	3940	4.32
UC2836D	D	SOIC	8	75	506.6	8	3940	4.32
UC2836D.A	D	SOIC	8	75	506.6	8	3940	4.32
UC2836DG4	D	SOIC	8	75	506.6	8	3940	4.32
UC3836D	D	SOIC	8	75	506.6	8	3940	4.32
UC3836D.A	D	SOIC	8	75	506.6	8	3940	4.32

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